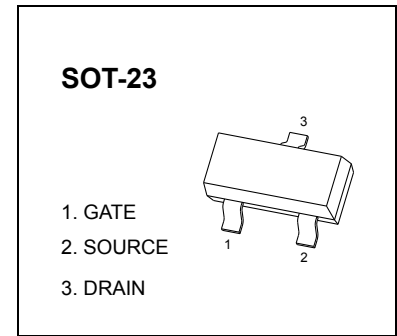




Features

2N7002K N-channel MOSFET

| | | |
|---------------|-----------------|-------|
| $V_{(BR)DSS}$ | $R_{DS(on)MAX}$ | I_D |
| 60V | 5Ω@10V | 340mA |
| | 5.3Ω@4.5V | |



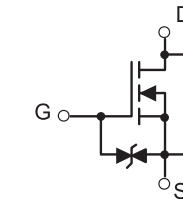
FEATURE

- High density cell design for Low $R_{DS(on)}$
- Voltage controlled small signal switch
- Rugged and reliable
- High saturation current capability
- ESD protected

APPLICATION

- Load Switch for Portable Devices
- DC/DC Converter

M5F-B; 7002K



Equivalent circuit

MOSFET MAXIMUM RATINGS ($T_a = 25^\circ\text{C}$ unless otherwise noted)

| Symbol | Parameter | Value | Unit |
|-----------------|---|----------|-------|
| V_{DS} | Drain-Source voltage | 60 | V |
| V_{GS} | Gate-Source voltage | ±20 | V |
| I_D | Drain Current | 340 | mA |
| P_D | Power Dissipation | 0.35 | W |
| T_J | Junction Temperature | 150 | °C |
| T_{stg} | Storage Temperature | -55~+150 | °C |
| $R_{\theta JA}$ | Thermal Resistance from Junction to Ambient | 357 | °C /W |



Features

MOSFET ELECTRICAL CHARACTERISTICS

T_a=25 °C unless otherwise specified

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|------------------------------------|---------------------|---|-------|-----|------|-------|
| Static Characteristics | | | | | | |
| Drain-Source Breakdown Voltage | V _{DS} | V _{GS} = 0V, I _D =250μA | 60 | | | V |
| Gate Threshold Voltage* | V _{GS(th)} | V _{DS} =V _{GS} , I _D =1mA | 1 | 1.3 | 2.5 | V |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} =48V, V _{GS} = 0V | | | 1 | μA |
| Gate -Source leakage current | I _{GSS1} | V _{GS} =±20V, V _{DS} = 0V | | | ±10 | μA |
| | I _{GSS2} | V _{GS} =±10V, V _{DS} = 0V | | | ±200 | nA |
| | I _{GSS3} | V _{GS} =±5V, V _{DS} = 0V | | | ±100 | nA |
| Drain-Source On-Resistance* | R _{DS(on)} | V _{GS} = 4.5V, I _D =200mA | | 1.1 | 5.3 | Ω |
| | | V _{GS} =10V, I _D =500mA | | 0.9 | 5 | Ω |
| Diode Forward Voltage | V _{SD} | V _{GS} =0V, I _S =300mA | | | 1.5 | V |
| Recovered charge | Q _r | V _{GS} =0V, I _S =300mA, V _R =25V, dI _S /dt=-100A/μS | | 30 | | nC |
| Dynamic Characteristics** | | | | | | |
| Input Capacitance | C _{iss} | V _{DS} =10V, V _{GS} =0V, f =1MHz | | | 40 | pF |
| Output Capacitance | C _{oss} | | | | 30 | pF |
| Reverse Transfer Capacitance | C _{rss} | | | | 10 | pF |
| Switching Characteristics** | | | | | | |
| Turn-On Delay Time | t _{d(on)} | V _{GS} =10V, V _{DD} =50V, R _G =50Ω, R _{GS} =50Ω, R _L =250Ω | | | 10 | ns |
| Turn-Off Delay Time | t _{d(off)} | | | | 15 | ns |
| Reverse recovery Time | t _{rr} | V _{GS} =0V, I _S =300mA, V _R =25V, dI _S /dt=-100A/μS | | 30 | | ns |
| GATE-SOURCE ZENER DIODE | | | | | | |
| Gate-Source Breakdown Voltage | BV _{GSO} | I _{GS} =±1mA (Open Drain) | ±21.5 | | ±30 | V |

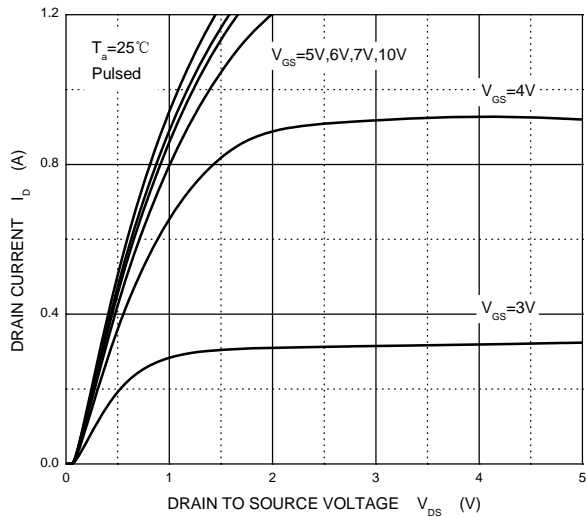
Notes :

*Pulse Test : Pulse Width ≤300μs, Duty Cycle ≤2%.

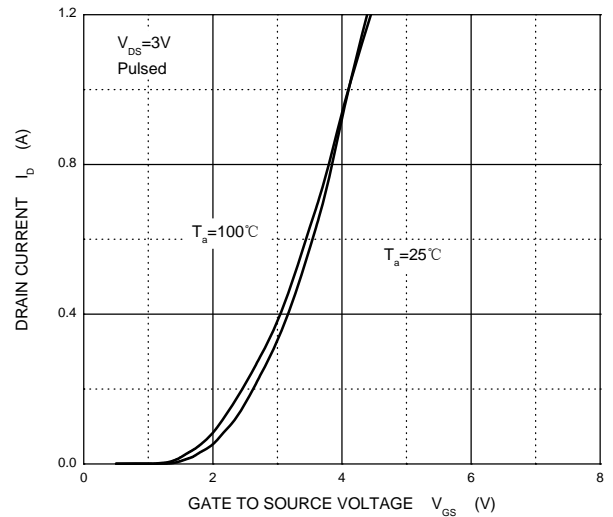
**These parameters have no way to verify.

Typical Characteristics

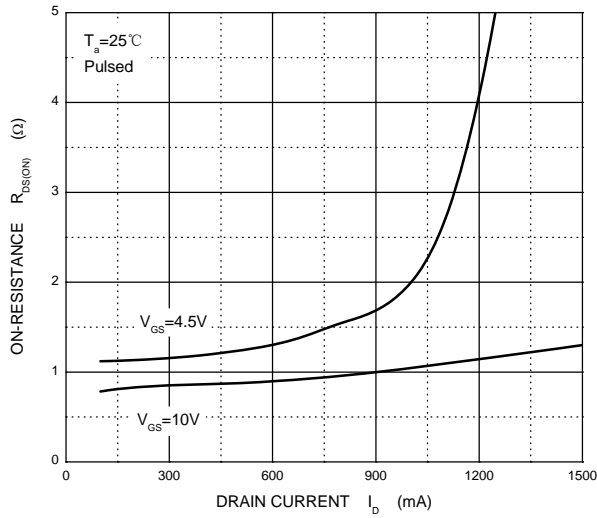
Output Characteristics



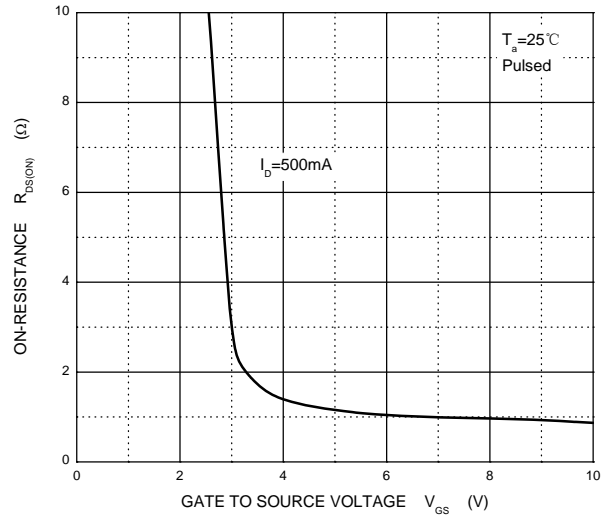
Transfer Characteristics



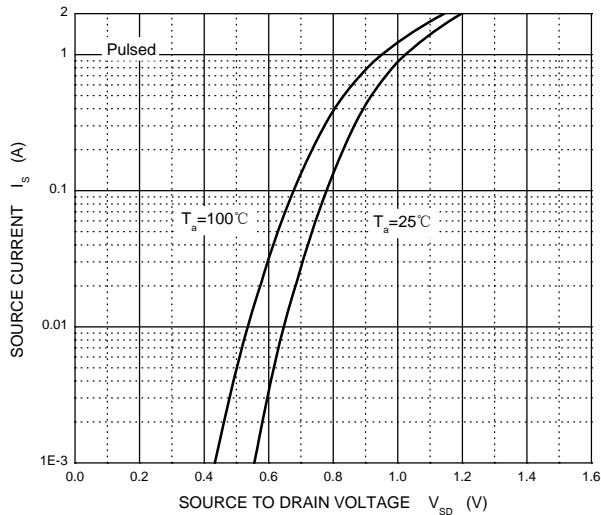
$R_{DS(ON)}$ — I_D



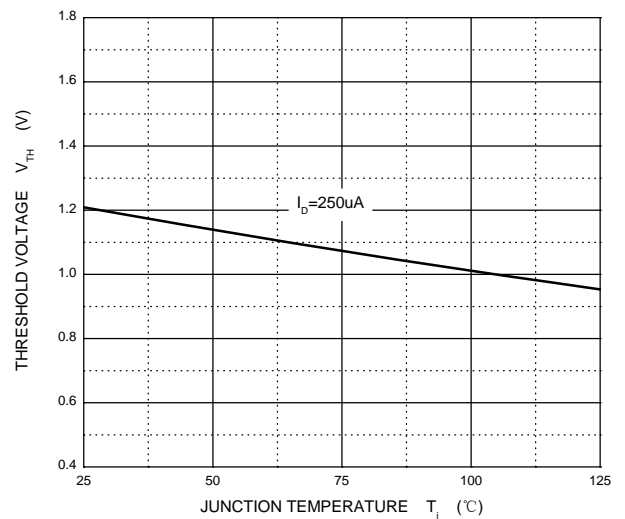
$R_{DS(ON)}$ — V_{GS}



I_S — V_{SD}



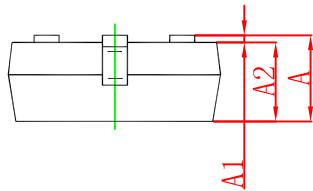
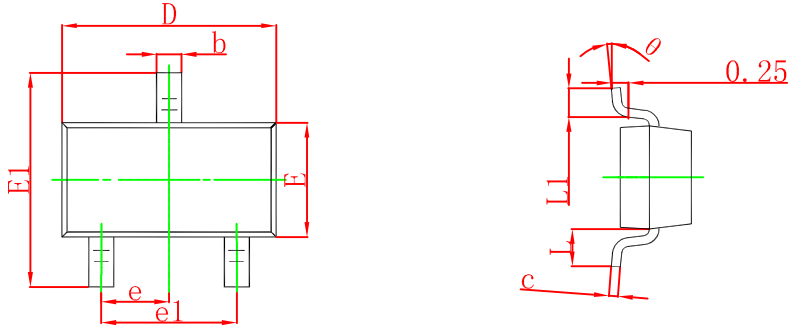
Threshold Voltage





Features

SOT-23 Package Outline Dimensions



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|-------|----------------------|-------|
| | Min | Max | Min | Max |
| A | 0.900 | 1.150 | 0.035 | 0.045 |
| A1 | 0.000 | 0.100 | 0.000 | 0.004 |
| A2 | 0.900 | 1.050 | 0.035 | 0.041 |
| b | 0.300 | 0.500 | 0.012 | 0.020 |
| c | 0.080 | 0.150 | 0.003 | 0.006 |
| D | 2.800 | 3.000 | 0.110 | 0.118 |
| E | 1.200 | 1.400 | 0.047 | 0.055 |
| E1 | 2.250 | 2.550 | 0.089 | 0.100 |
| e | 0.950 TYP | | 0.037 TYP | |
| e1 | 1.800 | 2.000 | 0.071 | 0.079 |
| L | 0.550 REF | | 0.022 REF | |
| L1 | 0.300 | 0.500 | 0.012 | 0.020 |
| θ | 0° | 8° | 0° | 8° |